30V, 16.5	Α, 14m Ω						
Features				General Description			
Max $r_{DS(on)} = 14m\Omega$ at $V_{GS} = 10V$, $I_D = 9.6A$ Max $r_{DS(on)} = 17m\Omega$ at $V_{GS} = 4.5V$, $I_D = 8.7A$ Low Profile - 1mm max in Power 33 RoHS Compliant		This N-Channel MOSFET is a rugged gate version Fairchild Semiconductor's advanced Power Tren process. It has been optimized for power manageme applications. Application ■ DC - DC Conversion					
]	Bottom		Тор				
	- 8		D				
5	7 8	D D D D D D D D D D D D D D D D D D D	D	S S S G	D 5 D 6 D 7 D 7		4 G - 3 S - 2 S - 1 S
5		Power 33	D	s ^S	D 6 D 7		-3 S -2 S
NOSFET		$\frac{1}{3}^{2}$ Power 33 n Ratings T _A = 25°C	D unless othe	s ^S	D 6 D 7	Batings	3 S 2 S 1 S
5 MOSFET Symbol	7 4 Maximur	$\frac{1}{3}^{2}$ Power 33 n Ratings T _A = 25°C Para	D	s ^S	D 6 D 7	Ratings 30	- 3 S - 2 S
5 MOSFET Symbol VDS	7 4 Maximur Drain to Sou	$\frac{1}{3}$ Power 33 Power 33 Para	D unless othe	s ^S	D 6 D 7	•	- 3 S - 2 S - 1 S - Unit
5 MOSFET Symbol Mos	7 Maximun Drain to Sou Gate to Sou	$\frac{1}{3}^{2}$ Power 33 n Ratings T _A = 25°C Para	unless othe	s ^S	D 6 D 7	30	3 S 2 S 1 S
5 AOSFET Symbol /GS	7 Maximun Drain to Sou Gate to Sou	$\frac{1}{3}$ Power 33 Power 34 P	unless othe ameter	s s	D 6 D 7	30 ±20	3 S 2 S 1 S Uni V
5 AOSFET Symbol /GS	7 Maximun Drain to Sou Gate to Sou	$\frac{1}{3}$ Power 33 Power 34 P	unless othe ameter	s s erwise noted $T_{C} = 25^{\circ}C$	D 6 D 7	30 ±20 16.5	3 S 2 S 1 S
5 MOSFET Symbol / _{DS} / _{GS}	7 Maximun Drain to Sou Gate to Sou	$\begin{array}{c} D\\ $	unless othe ameter	s s envise noted $T_{C} = 25^{\circ}C$ $T_{C} = 25^{\circ}C$ $T_{A} = 25^{\circ}C$	D 6 D 7 D 8	30 ±20 16.5 38	3 S 2 S 1 S Uni V
5 MOSFET Symbol /DS /GS	7 Maximun Drain to So Gate to Sou Drain Curre Power Diss	$\begin{array}{c} \begin{array}{c} & \\ & \\ & \\ & \\ & \\ \end{array} \end{array} \\ \begin{array}{c} & \\ & \\ & \\ \end{array} \\ \begin{array}{c} & \\ & \\ \end{array} \\ \begin{array}{c} & \\ & \\ \end{array} \\ \end{array} \\ \begin{array}{c} & \\ & \\ \end{array} \\ \end{array} \\ \begin{array}{c} & \\ & \\ \end{array} \\ \end{array} \\ \begin{array}{c} & \\ & \\ \end{array} \\ \end{array} \\ \begin{array}{c} & \\ & \\ \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} & \\ & \\ \end{array} \\ \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} & \\ & \\ \end{array} \\ \begin{array}{c} & \\ & \\ \end{array} \\$	unless othe ameter	S T _C = 25°C T _C = 25°C T _A = 25°C T _C = 25°C	D 6 D 7 D 8 (Note 1a)	30 ±20 16.5 38 9.6 60 31	- 3 S - 2 S - 1 S - 1 S - 1 A
AOSFET Symbol /os /os D	7 Maximun Drain to Sou Gate to Sou Drain Curre Power Diss Power Diss	Power 33 Power 34 Pow	unless other ameter e limited) mited)	s s mwise noted $T_{C} = 25^{\circ}C$ $T_{C} = 25^{\circ}C$ $T_{A} = 25^{\circ}C$ $T_{C} = 25^{\circ}C$ $T_{A} = 25^{\circ}C$	D 6 D 7 D 8	30 ±20 16.5 38 9.6 60 31 2.1	- 3 S - 2 S - 1 S - 2 S - 2 S - 1 S - 2 S - 2 S - 1 S - 2 S
AOSFET Symbol /os /os D Po	7 Maximum Drain to Sou Gate to Sou Drain Curre Power Diss Power Diss Operating a	$\begin{array}{c} \begin{array}{c} & \\ & \\ & \\ & \\ & \\ \end{array} \end{array} \\ \begin{array}{c} & \\ & \\ \end{array} \\ \end{array} \\ \begin{array}{c} & \\ & \\ \end{array} \\ \begin{array}{c} & \\ & \\ \end{array} \\ \end{array} \\ \begin{array}{c} & \\ & \\ \end{array} \\ \end{array} \\ \begin{array}{c} & \\ & \\ \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} & \\ & \\ \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} & \\ & \\ \end{array} \\ \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} & \\ \end{array} \\$	unless other ameter e limited) mited)	s s mwise noted $T_{C} = 25^{\circ}C$ $T_{C} = 25^{\circ}C$ $T_{A} = 25^{\circ}C$ $T_{C} = 25^{\circ}C$ $T_{A} = 25^{\circ}C$	D 6 D 7 D 8 (Note 1a)	30 ±20 16.5 38 9.6 60 31	- 3 S - 2 S - 1 S - 2 S - 2 S - 1 S - 2 S - 2 S - 1 S - 2 S
5 MOSFET Symbol V _{DS} V _{GS} D D T _J , T _{STG}	7 Maximun Drain to Sou Gate to Sou Drain Curre Power Diss Power Diss Operating a maracteristi	$\begin{array}{c} \begin{array}{c} & \\ & \\ & \\ & \\ & \\ \end{array} \end{array} \\ \begin{array}{c} & \\ & \\ \end{array} \\ \end{array} \\ \begin{array}{c} & \\ & \\ \end{array} \\ \begin{array}{c} & \\ & \\ \end{array} \\ \end{array} \\ \begin{array}{c} & \\ & \\ \end{array} \\ \end{array} \\ \begin{array}{c} & \\ & \\ \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} & \\ & \\ \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} & \\ & \\ \end{array} \\ \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} & \\ \end{array} \\$	D unless othe ameter e limited) mited)	s s mwise noted $T_{C} = 25^{\circ}C$ $T_{C} = 25^{\circ}C$ $T_{A} = 25^{\circ}C$ $T_{C} = 25^{\circ}C$ $T_{A} = 25^{\circ}C$	D 6 D 7 D 8 (Note 1a)	30 ±20 16.5 38 9.6 60 31 2.1	3 S 2 S 1 S Uni V

Device MarkingDevicePackageReel SizeTape WidthQuantityFDMC8878FDMC8878Power 337"8mm3000 units

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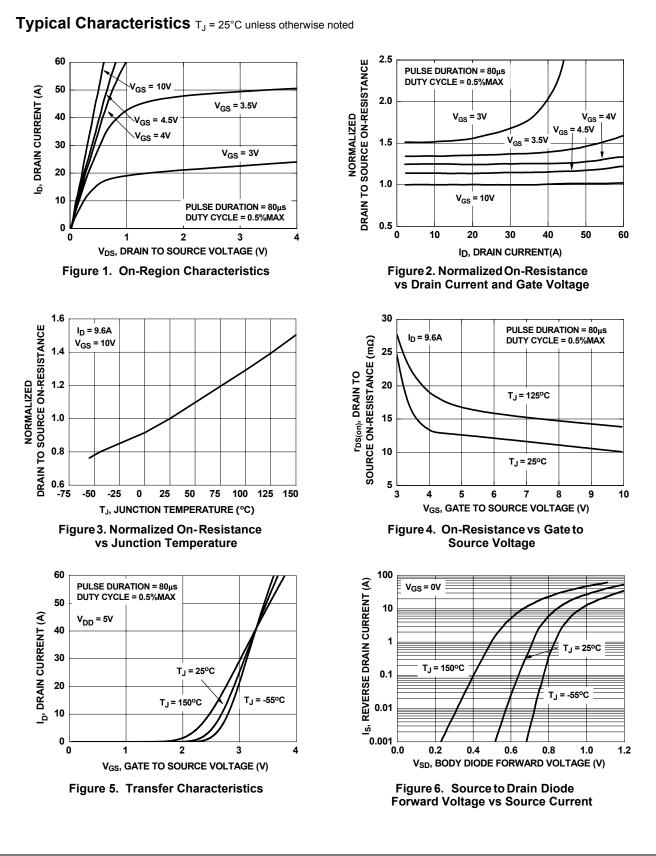
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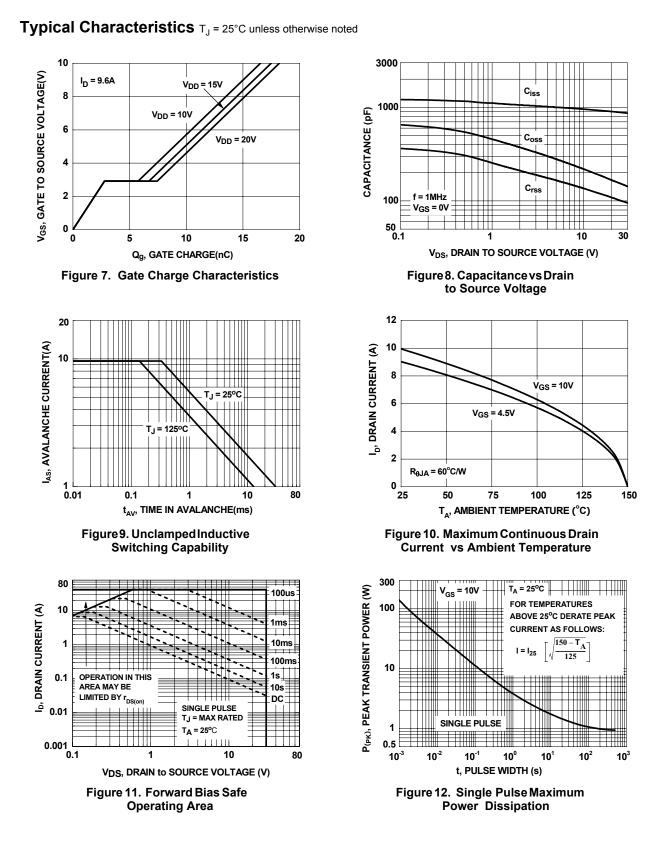
0 100 ±100 7 3 7 3 7 6 14.0 1 17.0 5 20.0 5) nA V mV/°C
1 100 ±100 7 3 7 6 6 14.0 .1 17.0 .5 20.0	mV/°C μA D nA V mV/°C mV/°C
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100 ±100 7 3 7 6 6 14.0 .1 17.0 .5 20.0) nA V mV/°C
±100 7 3 7 - 6 14.0 .1 17.0 .5 20.0) nA V mV/°C
7 6 14.0 1 17.0 5 20.0	mV/°C
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7 6 14.0 1 17.0 5 20.0	mV/°C
6 14.0 .1 17.0 .5 20.0	mΩ
.1 17.0 .5 20.0	mΩ
.5 20.0	
5	20.0
	S
5 1230	pF
0 255	pF
0 180	pF
1	Ω
16	ns
10	ns
) 36	ns
10	ns
3 26	nC
3	nC
}	nC
3 1.2	V
3 35	ns
21	nC
	10 36 36 10 8 26 8 9 8 1.2 3 35

2: Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%.

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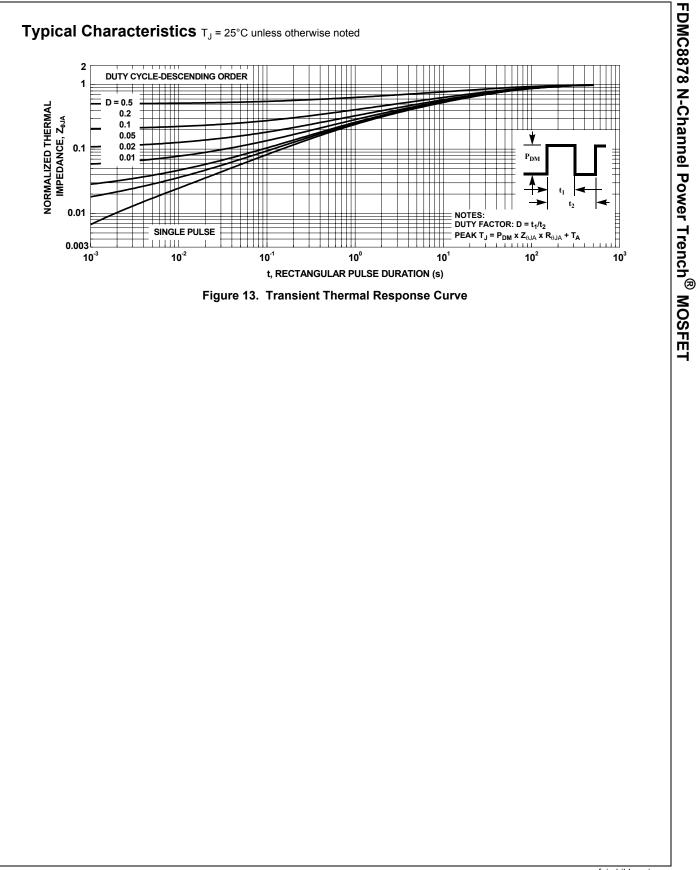


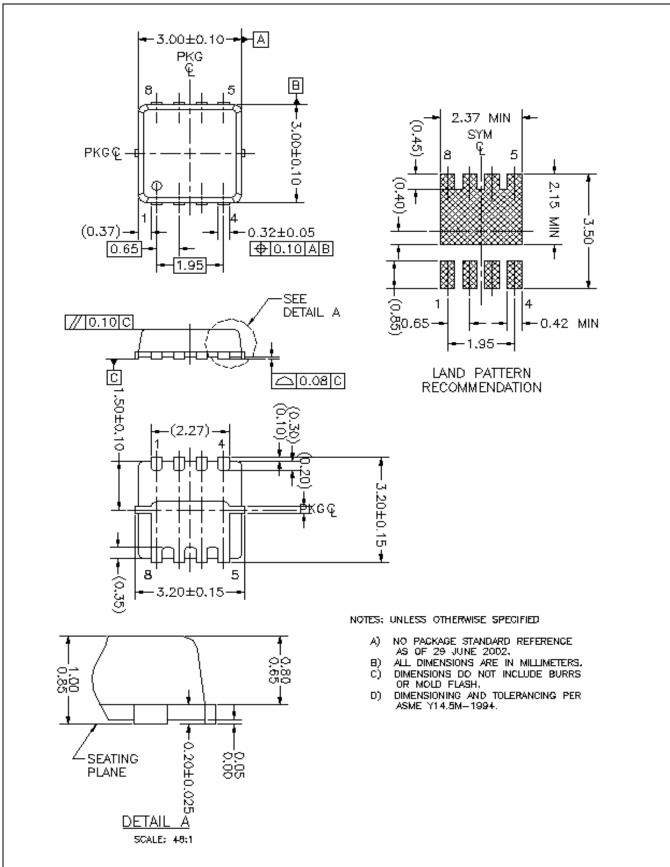
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